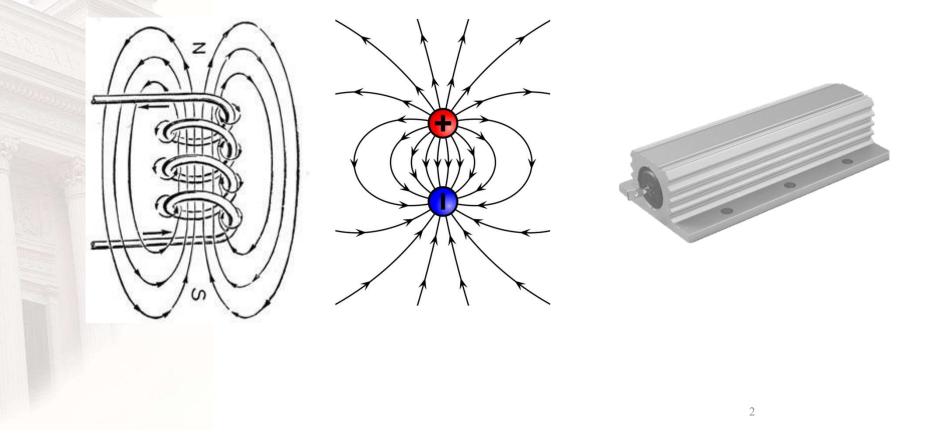
# **Power Electronics**

**Passive Components** 

## **Passive Components**



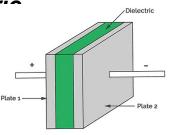
### **Types of Passive Components**

- Resistive
  - Heaters, some light sources, ...
- Inductive
  - Stores energy in magnetic fields
- Capacitive
  - Stores energy in electric fields







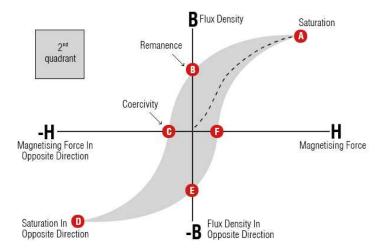




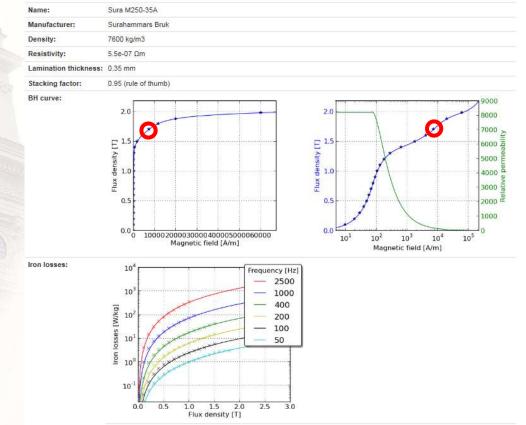
Electric

#### **Inductive Elements**

- Components
  - Inductors
  - Transformers
- Materials
  - Laminated alloys (e.g Silicon-steel, high saturation level, low frequency range)
  - Iron powder composites (lower magnetic saturation level, low to medium frequency range)
  - Ferrites (low saturation level, high frequency range)

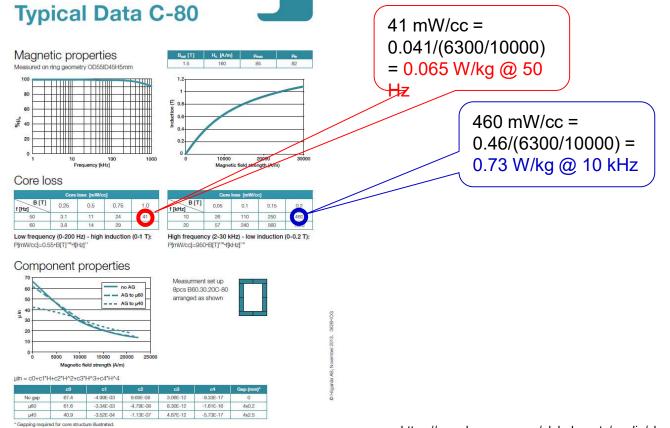


### Surahammars M250-35A - laminate



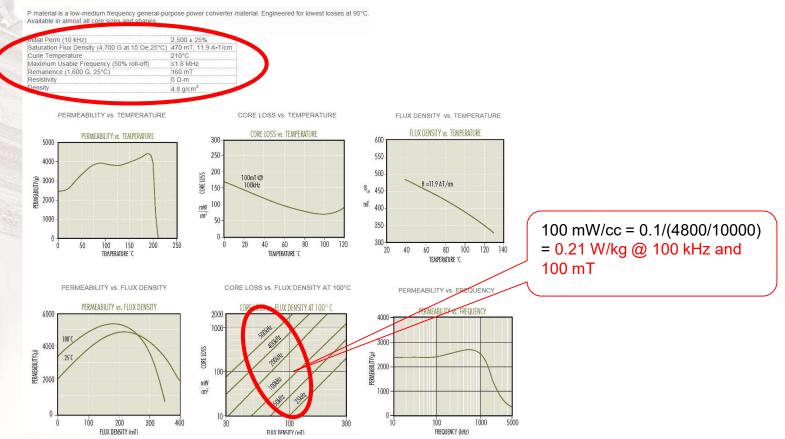
https://www.emetor.com/edit/materials/sura-m1000-100a/?cat=6&co=10

#### Soft Magnetic iron Powders Cores



https://www.hoganas.com/globalassets/media/sharepointdocuments/BrochuresanddatasheetsAllDocuments/Inductit\_C80.pdf

## **Ferrite Core material from Mg-Inc**



http://www.mag-inc.com/products/ferrite-cores/p-material

### **Inductive Elements - Core Losses**

- Core losses depend both on frequency and peak flux density
  - Usually specified in loss curves (one curve for certain frequencies)
  - Also analytical expressions like Steinmetz's formula:

#### Hysteresis losses

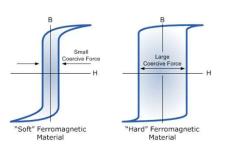
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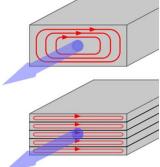
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#### $p_{Fe} = k_h f^{a_1} \hat{B}_{ac}^{a_2} + k_{ec} f^2 \hat{B}_{ac}^2 \qquad Eddy \ current}$

- One loop per period  $\rightarrow a_1 \approx 1$
- Loop roughly quadratic  $\rightarrow a_2 \approx 2$
- Steinmetz's formula includes two loss terms
  - Hysteresis loss
  - Eddy current loss
- Empirical expressions are provided by some core manufacturers

$$p_{Fe} = \frac{f}{\frac{a}{\hat{B}_{ac}^3} + \frac{b}{\hat{B}_{ac}^{2.3}} + \frac{c}{\hat{B}_{ac}^{1.65}}} + \left(df^2 \hat{B}_{ac}^2\right)$$





#### Inductor Dinductance $N \cdot i = \frac{\psi}{\mu_0 \cdot A \cdot N} \cdot \left(\frac{l_{fe}}{\mu_{fe}} + l_\delta\right)$ $A_{Fe}$ $L = \frac{d\psi}{di}$ $N \cdot i = H_{Fe} \cdot l_{Fe} + H_{\delta} \cdot l_{\delta}$ $l_{\delta}$ $L = \frac{\psi}{i} = \frac{\mu_0 \cdot A \cdot N^2}{\left(\frac{l_f e}{i_f e} + l_\delta\right)}$ $\int B_{Fe} = \mu_0 \mu_{Fe} H_{Fe}$ $B_{\delta} = \mu_0 H_{\delta}$ $N \cdot i = \frac{B_{Fe}}{\mu_0 \mu_{Fe}} \cdot l_{Fe} + \frac{B_{\delta}}{\mu_0} \cdot l_{\delta}$ $l_{\delta} \gg \frac{l_{fe}}{\mu_{fe}}$ Given a certain total design space, and... $\Phi = \frac{\psi}{N} = B_{Fe} A_{Fe} = B_{\delta} A_{\delta}$ · A desired inductance, L • An intended current level → A certain minimum $N \cdot i = \frac{\psi}{\mu_0 N} \cdot \left(\frac{l_{Fe}}{\mu_{Fe} A_{Fe}} + \frac{l_\delta}{A_\delta}\right)$ conductor area for resistive losses $L = \frac{\psi}{i} = \frac{\mu_0 \cdot A \cdot N^2}{l_\delta}$ ... then the number of turns (N) and the core area $(A_{fe})$ are in conflict. If one is to big, $B_{\delta} = B_{Fe} = B \Leftrightarrow A_{\delta} = A_{Fe}$ there will be no room for the other... Need for optimization!!!

### Where is the Energy in a magnetic circuit?

First, derive the total energy

$$W = \frac{1}{2} \cdot L \cdot i^{2} = \frac{1}{2} \cdot L \cdot \left(\frac{\psi}{L}\right)^{2} = \frac{1}{2} \cdot \frac{\psi^{2}}{L} = \begin{cases} A_{core} \approx A_{gap} = A \\ B_{fe} \approx B_{\delta} = B \\ \psi = N \cdot B \cdot A \end{cases} = \frac{1}{2} \cdot \frac{N^{2} \cdot B^{2} \cdot A^{2}}{\left(\frac{l}{\mu_{fe}} + l_{\delta}\right)} = \frac{1}{2} \cdot \frac{B^{2} \cdot A}{\mu_{0}} \cdot \left(\frac{l_{fe}}{\mu_{fe}} + l_{\delta}\right)$$

- Example:
  - $-l_{fe} = 200 \text{ mm}, l_{\delta} = 1 \text{ mm}$
  - $-\mu_{fe} = 10000$

$$\frac{l_{fe}}{\mu_{fe}} = 0.02 \text{ or } \frac{1}{50^{th}} \text{ of } l_{\delta}$$

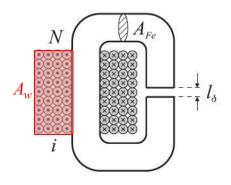
Conclusion: Almost all energy is bound in the air gap!

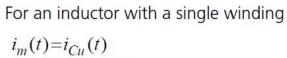
### **Inductor Core Size Selection**

$$\begin{split} \widehat{W}_{magn} &= \frac{1}{2} \cdot L \cdot \widehat{\imath}_{m}^{2} = \frac{1}{2} \cdot L \cdot \widehat{\imath}_{m} \cdot \widehat{\imath}_{m} = \\ &= \frac{1}{2} \cdot \frac{\mu_{0} \cdot A_{fe} \cdot N^{2}}{l_{\delta}} \cdot \widehat{\imath}_{m} \cdot \widehat{\imath}_{m} = \\ &= \frac{1}{2} \cdot N \cdot A_{fe} \cdot \frac{\mu_{0} \cdot \widehat{\imath}_{m} \cdot N}{l_{\delta}} \cdot \widehat{\imath}_{m} = \\ &= \frac{1}{2} \cdot N \cdot A_{fe} \cdot \widehat{B}_{m} \cdot \widehat{\imath}_{m} = \\ &= \frac{1}{2} \cdot N \cdot A_{fe} \cdot \widehat{B}_{m} \cdot J_{cu} \cdot A_{w} \cdot k_{cu} = \\ &= \frac{1}{2} \cdot N \cdot \widehat{B}_{m} \cdot J_{cu} \cdot k_{cu} \cdot A_{w} \cdot A_{fe} \\ &= \frac{1}{2} \cdot L \cdot \widehat{\imath}_{m} \cdot N \cdot I_{cu} \end{split}$$

$$\Rightarrow AP = A_{w} \cdot A_{fe} = \frac{L \cdot \widehat{\imath}_{m} \cdot I_{cu}}{\widehat{B}_{m} \cdot J_{cu} \cdot k_{cu}}$$

$$The more inductance or current, the bigger inductor bigger inductor with the smaller inductor induct$$



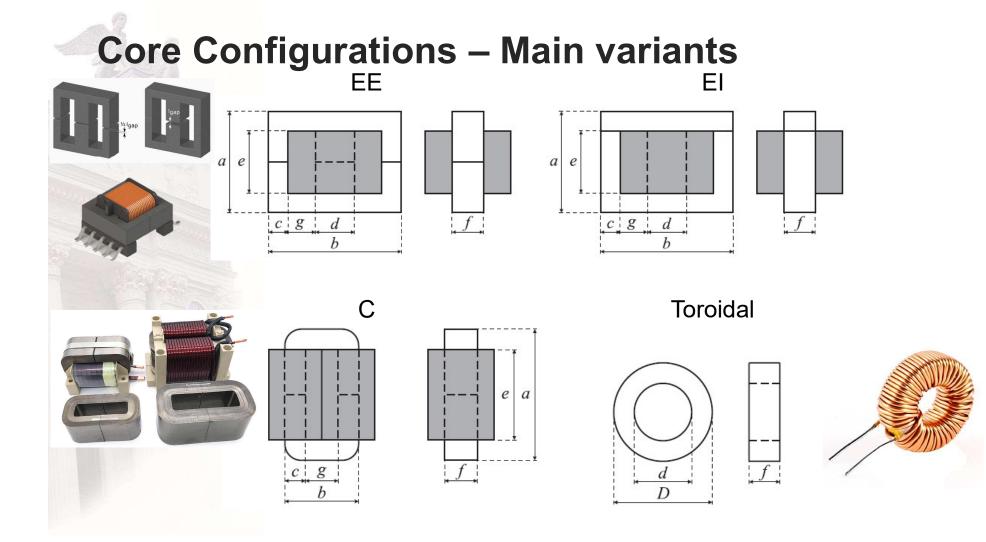


$$AP = \frac{L\hat{i}_{Cu}I_{Cu}}{k_{Cu}\hat{B}J_{Cu}}$$

For an inductor with several windings

$$A_{wI} = \frac{A_w}{N_w} = \frac{N A_{Cu}}{N_w k_{Cu}}$$

$$AP = N_w \frac{L_k \hat{i}_{m,k} I_{Cu,k}}{k_{Cu} \hat{B}_m J_{Cu}}$$



#### Inductor Design Example (I)

#### Inductor specification

 Table 5.4: Inductor specification.

 L 0.3 mH

  $I_{RMS}$  @ 1 kHz
 120 A

  $I_{PEAK}$  @ 5 kHz
 10 A

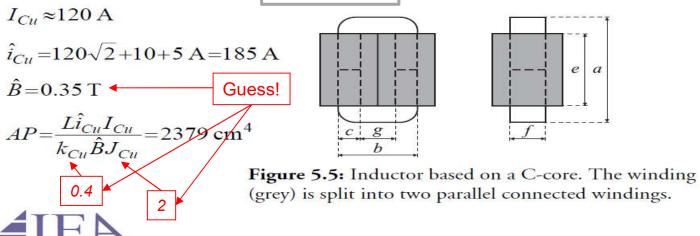
  $I_{PEAK}$  @ 10 kHz
 5 A

Area product

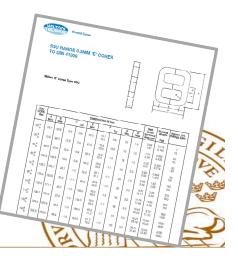
The C-core TELMAG Su 150b (Figure 5.5), have geometrical properties according Table 5.5.

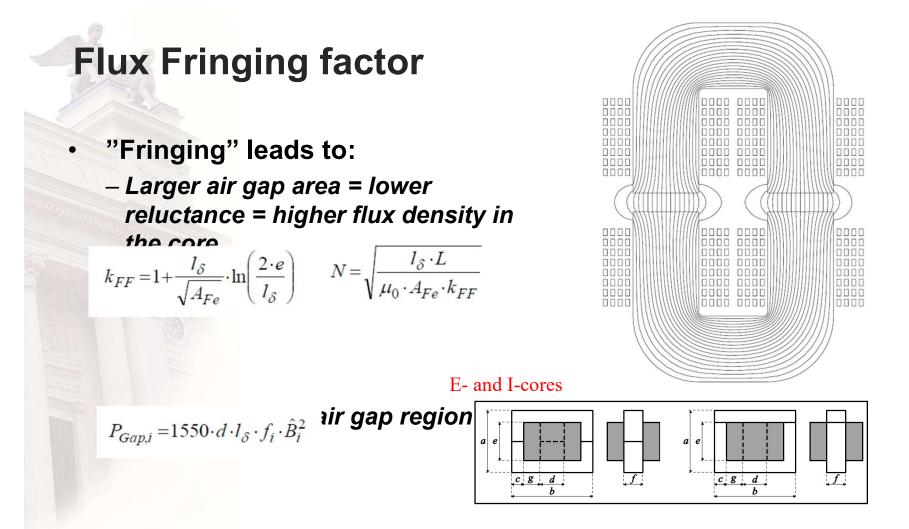
#### Table 5.5: Geometry of the core Su 150b.

a	255.6 mm
Ь	150.2 mm
С	49.4 mm
d	76.2 mm
е	154.0 mm
g	50.0 mm



 $AP = \frac{L \cdot \hat{\iota}_m \cdot I_{cu}}{\hat{B}_m \cdot J_{cu} \cdot k_{cu}}$ 





## **Lamination Stacking Factor**

 With thinner laminates, a larger part of the iron core is isolation material

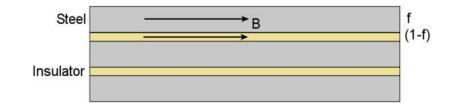
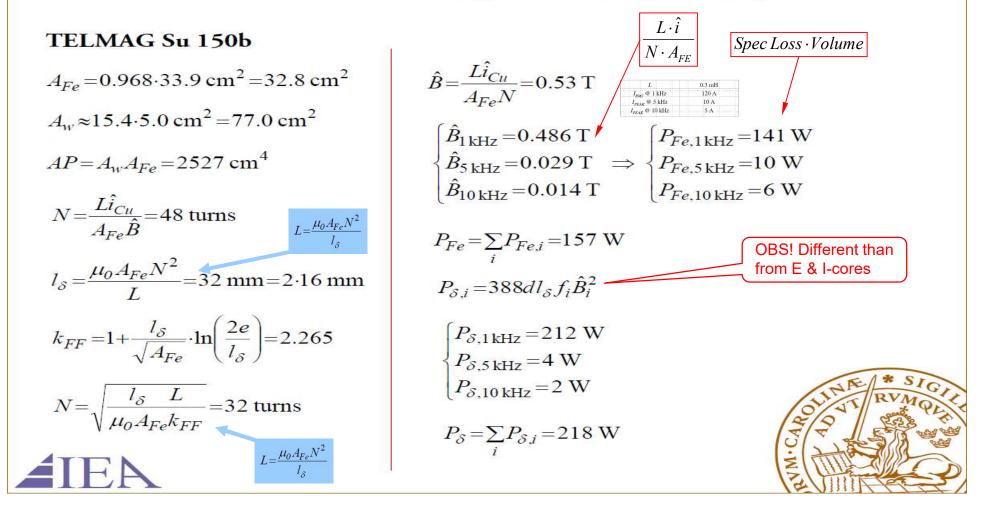


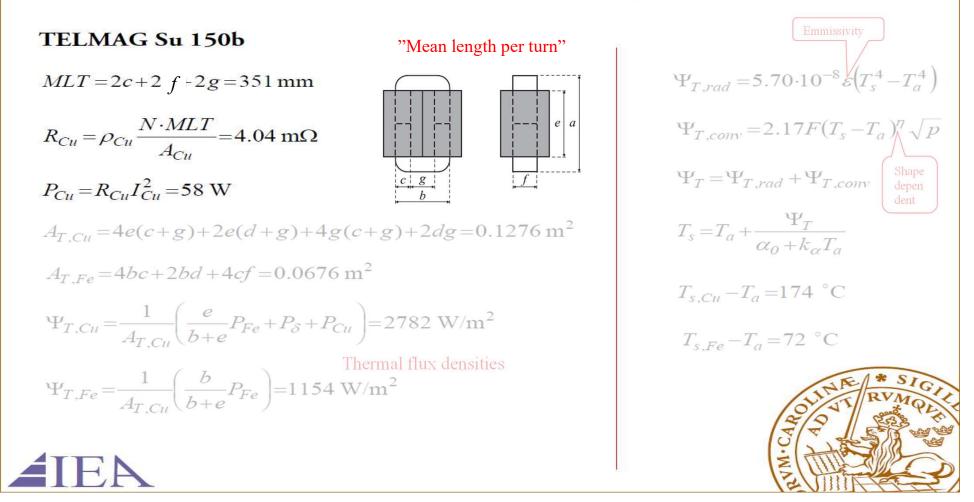
Table 5.3	Typical stacking factor $kFe$ for tape wound C cores as a function of th steel tape thickness [15].	
I	Lamination thickness [mm]	k <sub>Fe</sub>
	0.025	0.83
	0.05	0.89
	0.1	0.90
	0.18	0.92
	0.22 - 0.3	0.95

#### Electric

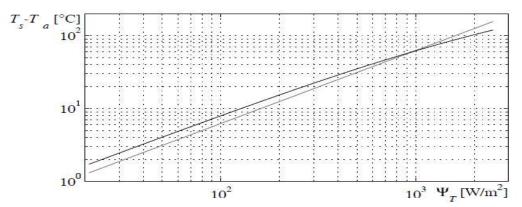
#### Inductor Design Example (II)



#### Inductor Design Example (III)



#### **Inductor Design Example (IV)**



**Figure 5.6:** Calculated temperature rise at an ambient temperature of 40 °C, based on radiated heat (black) and an approximate method (grey).

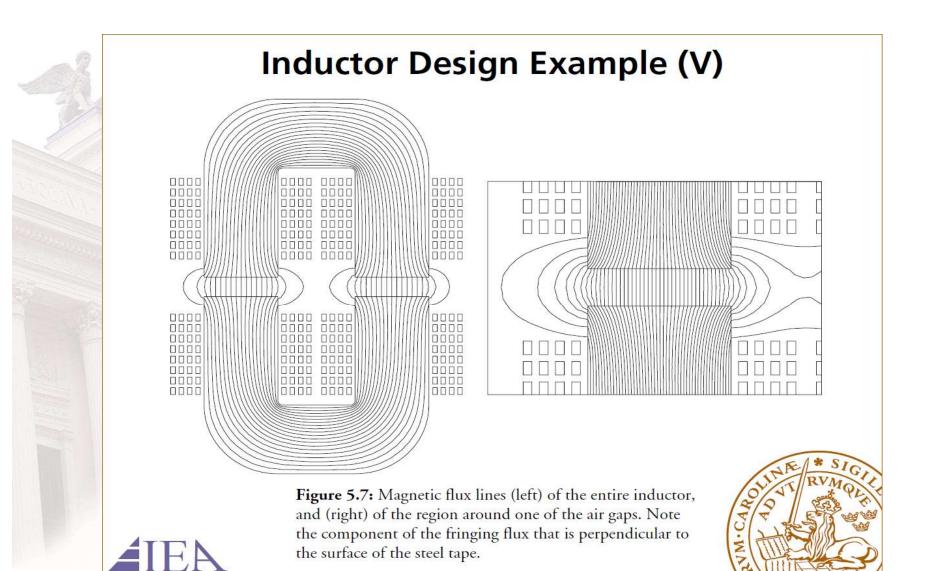
Air-gap losses not included  $\Rightarrow$ 

$$\Psi_{T,Cu} = \frac{1}{A_{T,Cu}} \left( \frac{e}{b+e} P_{Fe} + P_{Cu} \right) = 1074 \text{ W/m}^2$$

$$T_{s,Cu} - T_a = 67$$
 °C

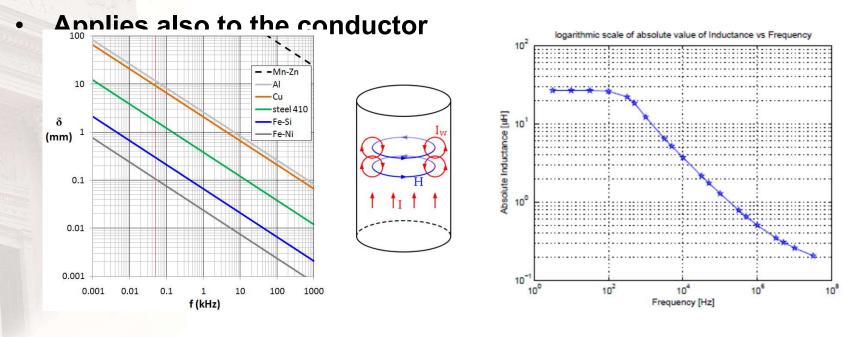






#### **Skin Depth – different metals**

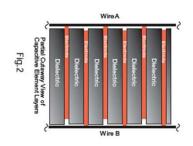
 Current induction in the core materials forces the flux outside the core

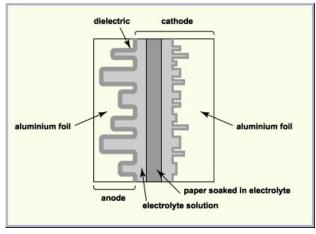


### **Capacitors - Design**

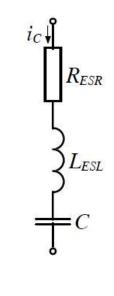
- Metallized film polypropylene capacitors
- thin plastic film to support the metal layer of the electrodes.
- the dielectric consists of a polypropylene film.
- to avoid air pockets resulting in a locally high electric field strength, the polypropylene film should be somewhat porous to be able to absorb oil.
- Wet aluminium electrolytic capacitors
  - contain a fluid, the electrolyte, between the aluminium electrodes.
  - the aluminium electrodes are electrically close together, only separated by the dielectric of the capacitor.
  - The dielectric constitutes of a thin aluminum oxide layer on the positive electrode.







## **Capacitors – equivalent circuit**



$$R_{ESR}(f) = R_s + \frac{\tan \delta_0}{2\pi f C}$$

$$P_{ESR}(f) = R_{ESR}(f) \cdot I_C^2(f)$$

$$R_{ESR} = \frac{P_{ESR}}{I_C^2}$$

# That's all folks...

